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**NTE2996
MOSFET
N-Channel, Enhancement Mode
High Speed Switch**

Features:

- Ultra Low On-Resistance
- Dynamic dv/dt Rating
- +175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated

Absolute Maximum Ratings:

Drain Current, I_D	
Continuous ($V_{GS} = 10V$)	
$T_C = +25^\circ C$ (Note 1) 84A
$T_C = +100^\circ C$ 59A
Pulsed (Note 2) 330A
Total Power Dissipation ($T_C = +25^\circ C$), P_D 200W
Derate Above $25^\circ C$ $1.4W/^\circ C$
Gate-Source Voltage, V_{GS} $\pm 20V$
Single Pulsed Avalanche Energy ($I_{AS} = 50A$, $L = 260\mu H$, Note 3), E_{AS} 320mJ
Avalanche Current (Note 2), I_{AR} 50A
Repetitive Avalanche Energy (Note 2), E_{AR} 17mJ
Peak Diode Recovery dv/dt (Note 4), dv/dt 4.0V/ns
Operating Junction Temperature Range, T_J -55° to $+175^\circ C$
Storage Temperature Range, T_{stg} -55° to $+175^\circ C$
Maximum Lead Temperature (During Soldering, 1.6mm from case, 10sec), T_L $+300^\circ C$
Maximum Thermal Resistance:	
Junction-to-Case, R_{thJC} $0.75^\circ C/W$
Junction-to-Ambient, R_{thJA} $62^\circ C/W$
Typical Thermal Resistance, Case-to-Sink (Flat, greased surface), R_{thCS} $0.50^\circ C/W$

Note 1. Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.

Note 2. Repetitive Rating: Pulse width limited by maximum junction temperature.

Note 3. This is a calculated value limited to $T_J = +175^\circ C$.

Note 4. $I_{SD} \leq 50A$, $di/dt \leq 230A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq +175^\circ C$.

Electrical Characteristics: ($T_J = +25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	60	-	-	V
Breakdown Voltage Temperature Coefficient	$\Delta V_{(\text{BR})\text{DSS}} / \Delta T_J$	Reference to $+25^\circ\text{C}$, $I_D = 1\text{mA}$	-	0.064	-	$\text{V}/^\circ\text{C}$
Static Drain-Source ON Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 50\text{A}$, Note 5	-	-	12	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.0	-	4.0	V
Forward Transconductance	g_{fs}	$V_{\text{DS}} = 25\text{V}, I_D = 50\text{A}$, Note 5	69	-	-	mhos
Drain-to-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0$	-	-	25	μA
		$V_{\text{DS}} = 48\text{V}, V_{\text{GS}} = 0\text{V}, T_C = +150^\circ\text{C}$	-	-	250	μA
Gate-Source Leakage, Forward	I_{GSS}	$V_{\text{GS}} = 20\text{V}$	-	-	100	nA
Gate-Source Leakage, Reverse		$V_{\text{GS}} = -20\text{V}$	-	-	-100	nA
Total Gate Charge	Q_g	$V_{\text{GS}} = 10\text{V}, I_D = 50\text{A}, V_{\text{DS}} = 48\text{V}$	-	-	130	nC
Gate-Source Charge	Q_{gs}		-	-	28	nC
Gate-Drain ("Miller") Charge	Q_{gd}		-	-	44	nC
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 30\text{V}, I_D = 50\text{A}, R_G = 3.6\Omega, V_{\text{GS}} = 10\text{V}$, Note 5	-	12	-	ns
Rise Time	t_r		-	78	-	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	48	-	ns
Fall Time	t_f		-	53	-	ns
Internal Drain Inductance	L_D	Between lead, 6mm (0.25") from package and center of die contact	-	4.5	-	nH
Internal Source Inductance	L_S		-	7.5	-	nH
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1\text{MHz}$	-	3210	-	pF
Output Capacitance	C_{oss}		-	690	-	pF
Reverse Transfer Capacitance	C_{rss}		-	140	-	pF
Source-Drain Diode Ratings and Characteristics						
Continuous Source Current	I_S	(Body Diode) Note 6	-	-	84	A
Pulse Source Current	I_{SM}	(Body Diode) Note 2	-	-	330	A
Diode Forward Voltage	V_{SD}	$T_J = +25^\circ\text{C}, I_S = 50\text{A}, V_{\text{GS}} = 0\text{V}$, Note 5	-	-	1.3	V
Reverse Recovery Time	t_{rr}	$T_J = +25^\circ\text{C}, I_F = 50\text{A}, \text{di/dt} = 100\text{A}/\mu\text{s}$, Note 5	-	73	110	ns
Reverse Recovery Charge	Q_{rr}		-	220	330	μC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$)				

Note 2. Repetitive Rating: Pulse width limited by maximum junction temperature.

Note 5. Pulse Width $\leq 400\mu\text{s}$, Duty Cycle $\leq 2\%$.

Note 6. Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.

